



L-Università  
ta' Malta

MATSEC  
Examinations Board



## Marking Scheme

SEC Engineering Technology Unit 3

Main Session 2019

9<sup>th</sup> April 2019

Marking schemes published by the MATSEC Examination Board are not intended to be standalone documents. They are an essential resource for markers who are subsequently monitored through a verification process to ensure consistent and accurate application of the marking scheme.

In the case of marking schemes that include model solutions or answers, it should be noted that these are not intended to be exhaustive. Variations and alternatives may also be acceptable. Examiners must consider all answers on their merits, and will have consulted with the MATSEC Examinations Board when in doubt.







C-4.	Justify the use of test bench equipment in relation to different scenarios.	5	6 marks	<p>(a) 1 mark</p> <p>(b) 2 marks</p> <p>(c) 1 mark</p> <p>(d) 2 marks</p>	<p>(a) Oscilloscope</p> <p>Since the audio frequency is between 20Hz and 20 kHz</p> <p>(b) Voltage Amplitude Periodic Time Maximum and Minimum Voltages Rise Fall time</p> <p>(Any two answers are accepted – 1 mark for each correct answer)</p> <p>(c) Multimeter</p> <p>(d) A multimeter can be used to take readings of: current voltage resistance capacitance</p>
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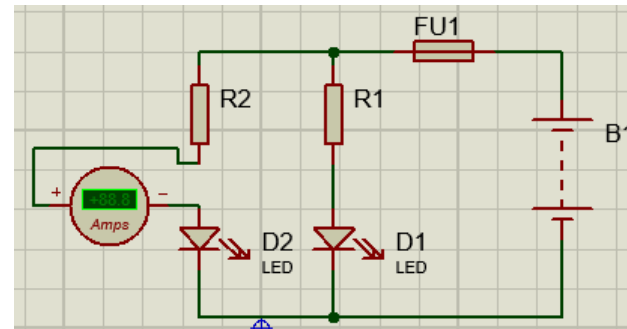


(b)  
(i) 1 mark

(b) Example of a correct answer:  
(i) the multimeter should be set to current DC (on the mA range) and the red terminal should be placed in the mA port. The anode(or cathode) of the LED should be disconnected and the current meter should be placed in series where the disconnection was carried out. Polarity should be observed to ensure the current value is positive.

(ii) 1 mark

(ii) the multimeter is drawn connected in series with D2.



C-5.	Identify the advantages and disadvantages of electronic boards.	7	6 marks	(a) 3 marks	<p>(a) Example of a correct answer:</p> <p><b>Advantages –</b></p> <p>The breadboard can be reused.</p> <p>No need to solder components.</p> <p>Replace componets quickly.</p> <p>Components not damaged by heat</p> <p>Useful when dealing with lcs.</p> <p><b>Disadvantges –</b></p> <p>Do not perform well with high frequencies.</p> <p>Cannot withstand high voltages.</p> <p>Cannot withstand high currents.</p> <p>Many jumpers required.</p> <p>Surface mount components cannot be used.</p> <p style="text-align: right;">(2 advantages and 1 disadvantage need to be mentioned)</p>
				(b) 3 marks	<p>(b) Example of a correct answer:</p> <p><b>Advantages –</b></p> <p>Low cost.</p> <p>Fixed components.</p> <p>Minimize short circuits.</p>

					<p>Easy to solder.</p> <p><b>Disadvantages –</b></p> <p>Complicated to repair (with no schematic diagram).</p> <p>Production causes environmental degradation.</p> <p>Fixed for specific use.</p> <p>(2 advantages and 1 disadvantage need to be mentioned)</p> <p>Answers which make technical sense should be accepted.</p>
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K-10.	Describe the soldering processes for prototypes and mass produced circuits.	8	4 marks	<p>(a) 0.5 mark for each step</p> <p>(b) 0.5 mark for each step</p>	<p>(a) Student needs to list the following items:</p> <ol style="list-style-type: none"> <li>1) Make sure components and pads are clean.</li> <li>2) Heat the pad and the component lead.</li> <li>3) Apply enough solder and allow it to flow.</li> <li>4) Remove the solder and soldering iron and allow joint to cool down.</li> </ol> <p>(b) Steps</p> <ol style="list-style-type: none"> <li>1) Silk Screening</li> <li>2) Surface Mount components</li> <li>3) Soldering baths</li> <li>4) Robotic assembly</li> </ol>
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